



ZXTP25040DFH

40V PNP MEDIUM POWER TRANSISTOR IN SOT23

### Features

- BV<sub>CEO</sub> > -40V
- BV<sub>ECO</sub> > -3V
- I<sub>C</sub> = -3A Continuous Collector Current
- V<sub>CE(sat)</sub> < -85mV @ -1A</li>
- R<sub>CE(sat)</sub> = 55mΩ typical
- P<sub>D</sub> = 1.25W
- High Power Dissipation SOT23 Package
- High Peak Current
- Low Saturation Voltage
- 3V Reverse Blocking Voltage
- Complementary Part Number: ZXTN25040DFH
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotiveproducts/.

This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

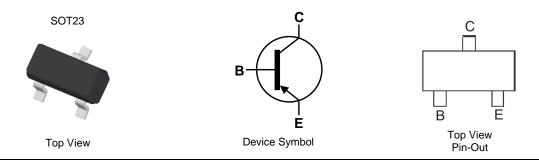
https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (2)
- Weight: 0.008 grams (Approximate)

## Applications

- MOSFET and IGBT gate driving
- DC-DC converters
- Motor drives
- High-side drivers



## Ordering Information (Note 4)

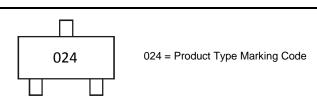
Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTP25040DFHTA	024	7	8	3,000

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**





## Absolute Maximum Ratings @ TA = +25°C, unless otherwise specified.

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-45	V
Collector-Emitter Voltage (Forward Blocking)	V <sub>CEO</sub>	-40	V
Emitter-collector voltage (Reverse Blocking)	V <sub>ECO</sub>	-3	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	lc	-3	A
Peak Pulse Current	І <sub>СМ</sub>	-9	A

#### Thermal Characteristics @ T<sub>A</sub> = +25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
	(Note 5)		0.73 5.84		
	(Note 6)		0.78 6.24		
Power Dissipation Linear derating factor	(Note 7)	PD	1.05 8.4	W mW/°C	
	(Note 8)		1.25 9.6		
	(Note 9)		1.81 14.5		
	(Note 5)		171		
	(Note 6)		160		
Thermal Resistance, Junction to Ambient	(Note 7)	R <sub>θJA</sub>	119	°C/W	
	(Note 8)		100	1	
	(Note 9)		69		
Thermal Resistance, Junction to Lead	(Note 10)	R <sub>θJL</sub>	74.95	°C/W	
Thermal Resistance, Junction to Case	(Note 11)	Rejc	45	°C/W	
Operating and Storage Temperature Range	_	TJ, TSTG	-55 to +150	°C	

Notes: 5. For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

6. Same as note (5), except the device is mounted on FR4 substrate PCB layout with minimum recommended pad layout.

7. Same as note (5), except the device is surface mounted on 25mm x 25mm with 2 oz copper. 8. Same as note (5), except the device is surface mounted on 50mm x 50mm with 2 oz copper.

Same as note (6), except the device is measured at t-5secs.
Thermal resistance from junction to solder-point (at the end of the collector lead).

11. Thermal resistance from junction to the top of the case.

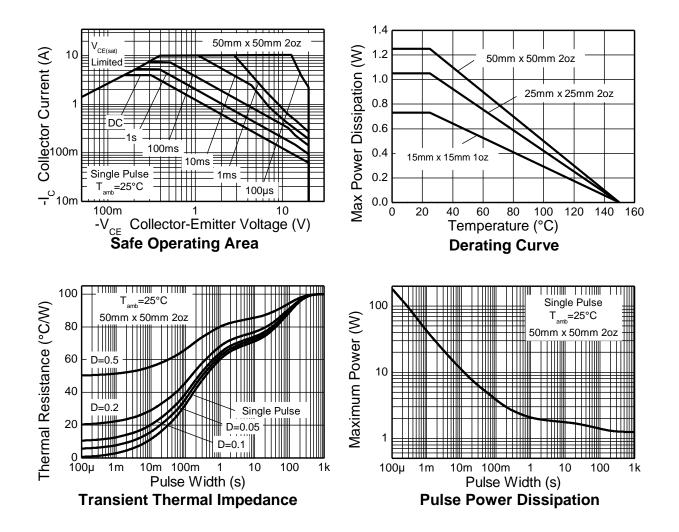
## ESD Ratings (Note 12)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

12. Refer to JEDEC specification JESD22-A114 and JESD22-A115. Note:



## **Thermal Characteristics and Derating Information**





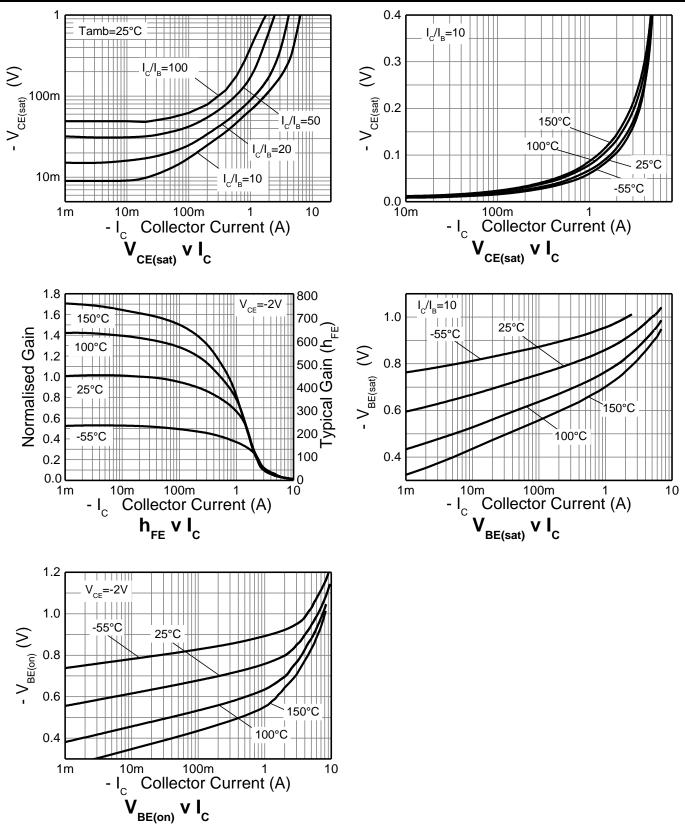
## Electrical Characteristics (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-45	-75	-	V	I <sub>C</sub> = -100μA
Collector-Emitter Breakdown Voltage (Note 13)	BV <sub>CEO</sub>	-40	-65	-	V	I <sub>C</sub> = -10mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.2	-	V	I <sub>E</sub> = -100μA
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	-3	-8.7	-	V	I <sub>E</sub> = -100μA
Collector-Base Cutoff Current		-	< -1	-50	nA	V <sub>CB</sub> = -45V
Collector-Base Cuton Cutterit	I <sub>CBO</sub>	-	-	-0.5	μA	$V_{CB} = -45V, T_{amb} = +100^{\circ}C$
Emitter-Base Cutoff Current	I <sub>EBO</sub>	-	< -1	-50	nA	V <sub>EB</sub> = -5.6V
		300	450	900		$I_{C} = -10 \text{mA}, V_{CE} = -2 \text{V}$
Static Forward Current Transfer Ratio (Note 13)	h <sub>FE</sub>	200	300	-	-	$I_{C} = -1A, V_{CE} = -2V$
		30	60	-		$I_{C} = -3A, V_{CE} = -2V$
		-	-170	-260		I <sub>C</sub> = -1A, I <sub>B</sub> = -20mA
Collector-Emitter Saturation Voltage (Note 13)	V <sub>CE(sat)</sub>	-	-65	-85	mV	I <sub>C</sub> = -1A, I <sub>B</sub> = -100mA
		-	-165	-220		I <sub>C</sub> = -3A, I <sub>B</sub> = -300mA
Base-Emitter Saturation Voltage (Note 13)	V <sub>BE(sat)</sub>	-	-930	-1000	mV	I <sub>C</sub> = -3A, I <sub>B</sub> = -300mA
Base-Emitter Saturation Voltage (Note 13)	V <sub>BE(on)</sub>	-	-830	-900	mV	I <sub>C</sub> = -3A, V <sub>CE</sub> = -2V
Output Capacitance	C <sub>obo</sub>	-	17.4		pF	V <sub>CB</sub> = -10V, f = 1MHz
Transition Frequency	fT	-	270	-	MHz	$V_{CE} = -10V, I_C = -50mA,$ f = 100MHz
Turn-on Time	t <sub>(on)</sub>	-	75.5	-	ns	$V_{CC} = -15V, I_C = -750mA,$
Turn-off Time	t <sub>(off)</sub>	-	320	-	ns	I <sub>B1</sub> = -I <sub>B2</sub> = -15mA

Note: 13. Measured under pulsed conditions. Pulse width  $\leq$  300 µs. Duty cycle  $\leq$  2%.



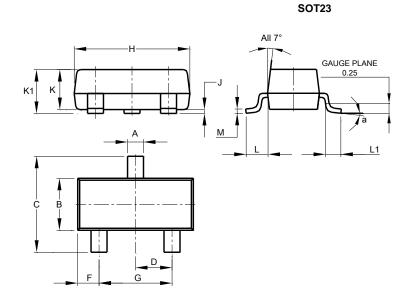






## **Package Outline Dimensions**

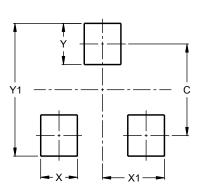
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT23					
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
в	1.20	1.40	1.30			
C	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)			
С	2.0			
Х	0.8			
X1	1.35			
Y	0.9			
Y1	2.9			



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